

L-Band Medium & High Power GaAs FET

FEATURES

• High Output Power: P_{1dB} = 36.0dBm (Typ.)

• High Gain: $G_{1dB} = 11.5dB$ (Typ.)

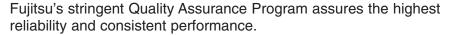
• High PAE: $\eta_{add} = 37\%$ (Typ.)

Proven Reliability

Hermetically Sealed Package

DESCRIPTION

The FLL57MK is a Power GaAs FET that is specifically designed to provide high power at L-Band frequencies with gain, linearity and efficiency superior to that of silicon devices. The performance in multitone environments for Class AB operation make them ideally suited for base station applications.





ABSOLUTE MAXIMUM RATING (Ambient Temperature Ta=25°C)

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	VDS		15	V
Gate-Source Voltage	VGS		-5	V
Total Power Dissipation	PT	T _C = 25°C	21.4	W
Storage Temperature	T _{stg}		-65 to +175	°C
Channel Temperature	T _{ch}		175	°C

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

- 1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
- 2. The forward and reverse gate currents should not exceed 32.2 and -2.2 mA respectively with gate resistance of 100Ω .
- 3. The operating channel temperature (T_{ch}) should not exceed 145°C.

ELECTRICAL CHARACTERISTICS (Ambient Temperature Ta=25°C)

lto.m	Cumbal	Test Conditions	Limit				
Item	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Saturated Drain Current	IDSS	V _{DS} = 5V, V _{GS} = 0V	-	1800	2700	mA	
Transconductance	9m	V _{DS} = 5V, I _{DS} = 1100mA	-	1000	-	mS	
Pinch-off Voltage	Vp	$V_{DS} = 5V, I_{DS} = 90mA$	-1.0	-2.0	-3.5	V	
Gate Source Breakdown Voltage	VGSO	IGS = -90μA	-5	-	-	V	
Output Power at 1dB G.C.P.	P _{1dB}	V 40V	35.5	36.0	-	dBm	
Power Gain at 1dB G.C.P.	G _{1dB}	VDS = 10V IDS = 0.55IDSS (Typ.), f = 2.3GHz	10.5	11.5	-	dB	
Power-added Efficiency	ηadd		-	37	-	%	
Thermal Resistance	R _{th}	Channel to Case	-	6.2	7.0	°C/W	

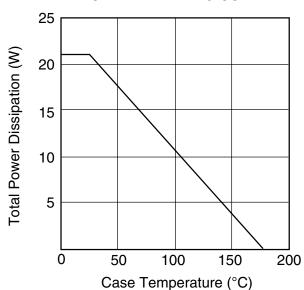
CASE STYLE: MK G.C.P.: Gain Compression Point



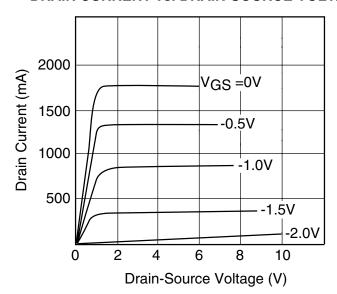
FLL57MK

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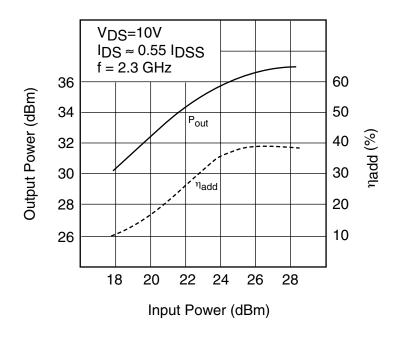
POWER DERATING CURVE



DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



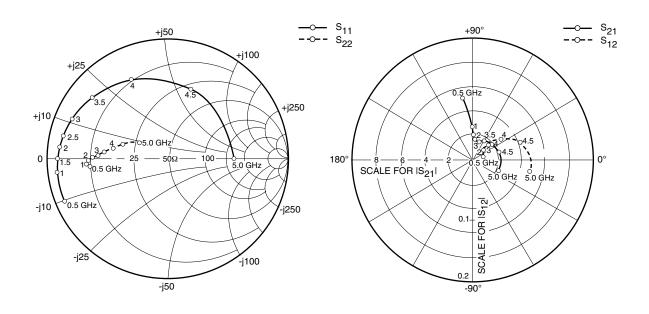
OUTPUT POWER vs. INPUT POWER





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S-PARAMETERS

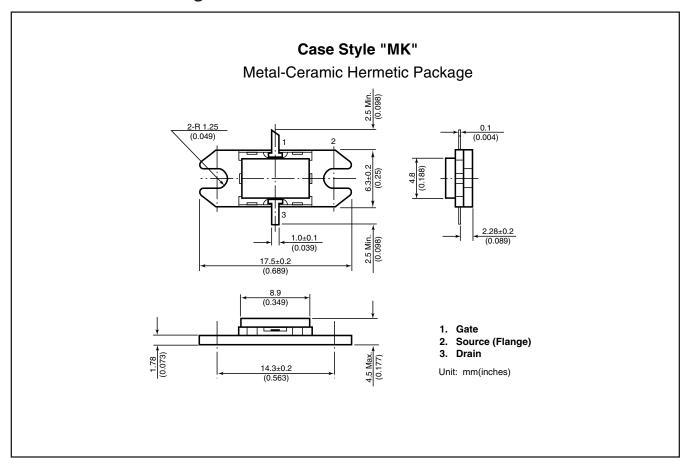
 $V_{DS} = 10V, I_{DS} = 800mA$

FREQUENCY	S11		S21		S1	S12		S22	
(MHZ)	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG	
500	.929	-157.5	5.115	99.7	.017	21.7	.661	-175.9	
1000	.927	-172.6	2.718	91.4	.018	24.6	.669	-176.5	
1500	.914	179.9	1.988	88.3	.020	34.4	.660	-177.7	
2000	.902	174.0	1.653	83.8	.022	41.1	.651	-178.8	
2500	.887	167.6	1.558	79.4	.026	48.7	.621	179.8	
3000	.856	157.0	1.534	72.3	.034	42.7	.584	177.7	
3500	.806	140.9	1.782	60.2	.040	47.0	.527	174.3	
4000	.725	114.8	1.888	39.3	.057	35.5	.465	169.3	
4500	.609	71.9	2.199	15.8	.082	19.7	.396	162.0	
5000	.548	-0.6	2.278	-24.0	.096	-11.8	.270	151.1	



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CAUTION

Fujitsu Compound Semiconductor Products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put these products into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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